

C1808C331KHRACTU

Aliases (C1808C331KHRAC7800)

SMD Comm X7R HV, Ceramic, 330 pF, 10%, 3,000 VDC, X7R, SMD, MLCC, High Voltage, Temperature Stable, 1808, 2.9 mm



General Information	
Series	SMD Comm X7R HV
Style	SMD Chip
Description	SMD, MLCC, High Voltage, Temperature Stable
Features	High Voltage
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	100 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
Т	2mm +/-0.15mm
S	2.9mm MIN
В	0.6mm +/-0.35mm

1000

Packaging Quantity

W	2mm +/-0.2mm	Tolerance	10%
Т	2mm +/-0.15mm	Voltage DC	300
S	2.9mm MIN	Dielectric Withstanding Voltage	3,60
В	0.6mm +/-0.35mm	Temperature Range	-55/
		Temp. Coefficient	X7R
Packaging Specifications		Capacitance Change with	15%,
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC	

Specifications	
Capacitance	330 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	3000 VDC
Dielectric Withstanding Voltage	3,600 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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